

IEEE 26th INTERNATIONAL SYMPOSIUM ON THE PHYSICAL AND FAILURE ANALYSIS OF INTEGRATED CIRCUITS

- IPFA 2019 -

02 – 05 July 2019

Grand Hyatt Hotel, Hangzhou, China

EXHIBITION INFORMATION AND BOOKING

1. The IPFA 2019 Exhibition will be held from 03 to 05 July 2019 at Grand Hyatt Hotel, Hangzhou. The symposium will be held at the conference room in front of the exhibition. The tea-breaks and luncheons for all symposium participants will be held at the function area near the exhibition hall.

2. The dates of the exhibition are:

	<u>Exhibition</u>	<u>In Conjunction With:</u>
02 July 2019 (3.00pm-9.00pm)	Move In/Set up	Tutorial Sessions
03 to 05 July 2018	Exhibition	Symposium
05 July 2018 (2.30pm onwards)	Move out/Tear Down	Symposium

3. The cost of a standard shell scheme booth (3m x 3m) for the exhibition period is 4,600 USD and 3,200 USD for the 2m x 2m standard shell scheme booth. Both rates include one complimentary room for one night stay at the Grand Hyatt Hotel, Hangzhou, one complimentary registration (2 registrations for 3m x 3m booths) for the symposium from 03 to 05 July 2019. A copy each of the perspective views of both the standard shell scheme booths is enclosed. Both the standard shell scheme booths comprise:

- White laminated wall partitions with fire retardant infill c/w aluminium frames and poles
- Fascia board with company's name and booth number in vinyl stickers
- Information desk
- White folding chair
- Wastepaper basket
- Fluorescent tube (40W)
- Single-phase power point (13amps/220V)
- Please contact the Exhibition Chair and indicate the detailed wattage if you need three-phase power supply.

4. For booking, please fill in the Booking Form below and send it to the IPFA2019 Exhibition Chair's email address. For the balance transfer*, please contact the IPFA2019 Exhibition Chair for the destination bank account information. (Exhibition Chair's Email: ipfa2019_Exh@hotmail.com)

BOOKING FORM

- Yes, I am pleased to confirm _____ unit of [3m x 3m OR 2m x 2m]** booth(s) for the IPFA 2019 Exhibition. I prefer Booth No: 1st Choice _____ 2nd Choice _____ and understand that this will be on a first-come-first served basis.
- I hereby transfer the amount: _____ as full payment for the confirmation.

Organisation:		
Contact Person:		Designation:
Tel:	Fax:	Email:
Address:		
Country:		Postal Code:
Authorised Signature:		Date:

*The amount must be in USD or RMB. If you wish to pay by other modes, please contact the Exhibition Chair.

**Please indicate how many booths and circle the preferred booth size.

ORGANIZED BY:



Reliability / Electronics Packaging /
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TECHNICALLY CO-SPONSORED BY:



EXHIBITION CHAIR:

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Website: www.ieee-ipfa.org